

**NTE649D, NTE649G,
NTE649J, NTE649M
Fast Rectifier
DO-214AC (SMA) Type Package**

Maximum Ratings and Electrical Characteristics: ($T_A = +25^\circ\text{C}$, Note 1, unless otherwise specified)

Maximum Repetitive Reverse Voltage, V_{RRM}

NTE649D	200V
NTE649G	400V
NTE649J	600V
NTE649M	1000V

Average Rectified Forward Current ($T_A = +100^\circ\text{C}$), $I_F(\text{AV})$ 1A

Non-Repetitive Peak Forward Surge Current (8.3ms Single Half Sine-Wave), I_{FSM} 30A

Power Dissipation, P_D 1.19W

Forward Voltage ($I_F = 1\text{A}$), V_F 1.3V

Reverse Recovery Time ($I_F = 0.5\text{A}$, $I_R = 1\text{A}$, $I_{rr} = 0.25\text{A}$), t_{rr}

NTE649D, NTE649G	150ns
NTE649J	250ns
NTE649M	500ns

Reverse Current (at Rated V_R), I_R

$T_A = +25^\circ\text{C}$	5 μA
$T_A = +125^\circ\text{C}$	50 μA

Total Capacitance ($V_R = 4\text{V}$, $f = 1\text{MHz}$), C_T 10pF

Operating Junction Temperature Range, T_J -55° to $+150^\circ\text{C}$

Storage Temperature Range, T_{stg} -55° to $+150^\circ\text{C}$

Thermal Resistance (Note 2)

Junction-to-Ambient, R_{thJA} 105 $^\circ\text{C}/\text{W}$

Junction-to-Lead, R_{thJL} 32 $^\circ\text{C}/\text{W}$

Note 1. Stresses exceeding the "Absolute Maximum Ratings" may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The "Absolute Maximum Ratings" are stress ratings only.

Note 2. Device mounted on FR-4 PCB 0.013mm.

